Board Characteristics

1. All dimensions in mm, unless specified
2. Minimum trace width: 4 mils
3. 0.5 Oz Copper on all layers
5. Polyimide Coverlay (Kapton Soldermask) on Top and Bottom, as per Gerbers
6. Soft Au finish (ENIG) for Al wire bonding and hand soldering on all pads.
7. Place Stiffener on Bottom side of Flex PCB
7.1. Stiffener Dimensions and position as shown.
7.2. Note stiffener rectangular cutout area around connector pins.
7.3. Total flex circuit thickness cannot exceed 0.012", not including stiffener